

# U.S. CHIPS Act funding for Texas Instruments



## DIRECT FUNDING

**\$1.6 billion**

for the construction of three wafer fabs in Texas and Utah

## ESTIMATED INVESTMENT TAX CREDIT

**~\$6-8 billion**

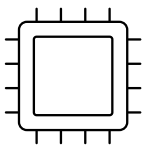
benefit for all qualified U.S. manufacturing investments

## WORKFORCE DEVELOPMENT GRANT

**\$10 million**

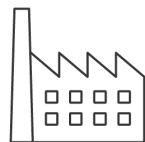
to train and develop a skilled workforce

## Building the next era of semiconductor manufacturing



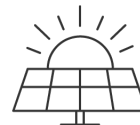
### CREATING A BETTER WORLD

100s of millions of analog and embedded processing chips manufactured daily



### DEPENDABLE 300MM CAPACITY

28-180nm process technologies optimized for TI's broad portfolio



### POWERED SUSTAINABLY

300mm wafer fabs powered by 100% renewable electricity



### DEVELOPING A STRONG WORKFORCE

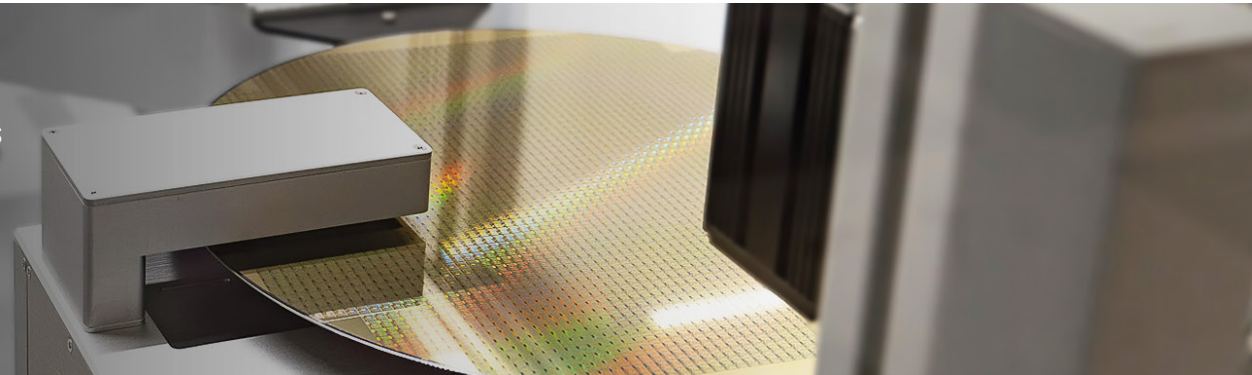
2,000+ new TI jobs and 1,000s of indirect jobs; 40 academic, military and vocational engagements

# TI's 300mm wafer fab manufacturing

Providing geopolitically dependable, 300mm semiconductor capacity at scale

## Connected, large-scale wafer fabs

- State-of-the-art infrastructure and processes
- Operational efficiencies
- Talent and technology sharing
- Robust business continuity



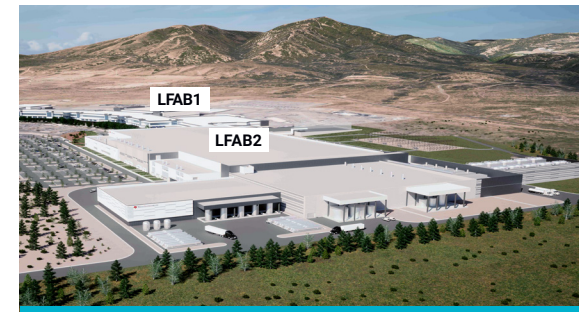
### Richardson, Texas

TI opened the world's first 300mm analog wafer fab, RFAB1, in Richardson in 2009. A second 300mm fab, RFAB2, opened in 2022 and is connected to RFAB1.



### Sherman, Texas

Building on a 70+ year history in Sherman, TI plans to build up to four new 300mm wafer fabs. The first two fabs, SM1 and SM2, will be connected and are currently under construction.



### Lehi, Utah

In 2021, TI purchased a 300mm wafer fab, LFAB1, located in Lehi. TI is building a second 300mm fab, LFAB2, which will connect to LFAB1.